Supporting Information

Large-area Freestanding Gold Nanomembranes with Nanoholes

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In-plane modulus measurement

The in-plane modulus measurements were performed as per method described by Vucaj et. al.¹ with Bruker Nanoscope V Multimode 8 Atomic Force Microscope (AFM), using Tap 300 Al-G tips from Innovative Solutions Bulgaria Ltd. Before the measurement the cantilever was calibrated for sensitivity on a quartz substrate, with the measured value being of 42.8 nm/V. The spring constant of the tip was calculated using thermal resonance spectra of the cantilever as per Sauder method² with the value being 15.6 N/m at the resonant frequency of 293 kHz. Prior to the test the measured area was inspected by optical microscope to avoid measurements on buckled film. Each sample was tested at 5 different spots in the centre of the mesh.

Following the test, the slope of the force curves (F/S) was measured by performing linear fit on the collected curves in the contact zone. The average value of these slopes was then used to calculate the flexural rigidity *D* of the film: $D=0.0056*L^{2*}|F/S|$, where, where *L* is the length of the edge of the TEM grid. This value was finally used to calculate the in-plane modulus $E_{in-plane} = D*12*(1-v^2)/t^3$, where *v* is the Poisson ratio of the gold film $v = 0.44^4$ and t is thickness of the film⁵.



Figure S1 Release process of a freestanding gold nanomembrane (NM, 50-nm-thin). The FeCl₃ solution gradually etched the sacrificial copper layer and released the NM from the Si template. Finally, the NM floated on the surface of the solution. Typically, the saturated 30% FeCl₃ solution or commercial FeCl₃-based copper etchant (Sigma-Aldrich) were used to get high etching efficiency. The Si template was settled in an oblique angle less than 30°. With these conditions, the etching process for wafer scale NMs is usually completed in 2 hours. The released NMs can be transferred to the surface of diluted HCl solution (2%) and then deionized water to remove the FeCl₃ residue on them.



Figure S2 Release and free the 100-nm-thin gold NMs from the solution: (i) place the template with the gold NM (attached on a plastic support ring with a string) at the bottom of a container with FeCl₃ etching solution; (ii) after completely etching the copper sacrificial layer, pull the support with the gold NM up with caution; (iii) continue to pull the support to the stand-up position and release the string; (iv) slowly siphon the solution out of container to maintain equal pressures on both sides of the NM and thus avoid any damage.



Figure S3 Top: examples of focus-ion-beam (FIB) milled micro-beams and springs; Middle: serious structure damage and unbalance induced by high dose ion cutting; Bottom: top-view of several 3D-transformed structures.



Figure S4 Cutting sequences for the micro-butterfly and spring in Figure 3 to keep these irregular objects in balance after shaping. Generally, continuous cutting along one direction should be avoided as much as possible.

References

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